

Single/Dual/Quad, SOT23, Single-Supply, High-Speed, Low-Power Comparators

ABSOLUTE MAXIMUM RATINGS

Supply Voltage (V_{CC}).....+6V
 SHDN (MAX998).....-0.3V to 6V
 All Other Pins.....-0.3V to ($V_{CC} + 0.3V$)
 Current into Input Pins..... $\pm 20mA$
 Duration of Output Short Circuit to GND or V_{CC}Continuous
 Continuous Power Dissipation ($T_A = +70^\circ C$)
 6-Pin SOT23-6 (derate 7.1mW/ $^\circ C$ above $+70^\circ C$)571mW

8-Pin μ MAX (derate 4.10mW/ $^\circ C$ above $+70^\circ C$)330mW
 8-Pin SO (derate 5.88mW/ $^\circ C$ above $+70^\circ C$).....471mW
 16-Pin Narrow SO (derate 8.70mW/ $^\circ C$ above $+70^\circ C$) ..696mW
 16-Pin QSOP (derate 8.33mW/ $^\circ C$ above $+70^\circ C$).....667mW
 Operating Temperature Range-40 $^\circ C$ to +85 $^\circ C$
 Storage Temperature Range-65 $^\circ C$ to +160 $^\circ C$
 Lead Temperature (soldering, 10s)+300 $^\circ C$

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

($V_{CC} = +2.7V$ to $+5.5V$, $V_{CM} = 0V$, $T_A = -40^\circ C$ to $+85^\circ C$, unless otherwise noted. Typical values are at $T_A = +25^\circ C$.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Supply Voltage Range	V _{CC}	Inferred from PSRR test		2.7		5.5	V
Supply Current per Comparator	I _{CC}	V _{CC} = 5.5V			300	650	μA
		V _{CC} = 2.7V			225		
Shutdown Supply Current	I _{SD}	MAX998 only, $\overline{\text{SHDN}}$ = GND			1	500	nA
Power-Supply Rejection Ratio	PSRR	2.7V < V _{CC} < 5.5V		63	100		dB
Common-Mode Voltage Range	V _{CMR}	(Note 2)		-0.2	V _{CC} - 1.2		V
Common-Mode Rejection Ratio	CMRR	-0.2V ≤ V _{CM} ≤ (V _{CC} - 1.2V)		66	95		dB
Input Offset Voltage	V _{OS}	V _{CC} = 5V (Note 3)	T _A = +25°C		0.2	±2	mV
			T _A = T _{MIN} to T _{MAX}			±3	
Input-Referred Hysteresis	V _{HYS}	V _{CC} = 5V (Note 4)	MAX976EUA, MAX998EUT	0.3	1.5	5.0	mV
			All others	0.5	1.5	4.0	
Input Bias Current	I _B				75	300	nA
Input Offset Current	I _{OS}				±5	±100	nA
OUT Output-Voltage High	V _{OH}	I _{SOURCE} = 2mA, V _{CC} - V _{OH}			0.1	0.4	V
OUT Output-Voltage Low	V _{OL}	I _{SINK} = 2mA			0.1	0.4	V
OUT Short-Circuit Current	I _{SH}	V _{CC} = 5.5V	Sinking		74		mA
			Sourcing		90		
Input Capacitance	C _{IN}				3		pF
$\overline{\text{SHDN}}$ Input-Voltage High	V _{IH}	MAX998 only		0.65 x V _{CC}			V
$\overline{\text{SHDN}}$ Input-Voltage Low	V _{IL}	MAX998 only		0.2 x V _{CC}			V
OUT Leakage Current	I _{OUT}	MAX998 only, $\overline{\text{SHDN}}$ = GND, V _{OUT} = 0V to V _{CC}			1	200	nA
$\overline{\text{SHDN}}$ Input Current	I $\overline{\text{SHDN}}$	MAX998 only			1	200	nA
Propagation Delay	t _{PD}	C _{LOAD} = 10pF, V _{CC} = 5V (Note 5)	Overdrive = 5mV		28		ns
			Overdrive = 50mV		20	40	
Propagation-Delay Skew	t _{SKEW}	C _{LOAD} = 10pF (Note 6)			2		ns
Propagation-Delay Matching Between Channels	Δt _{PD}	MAX976/MAX978 only			1		ns
Output Rise/Fall Time	t _R /t _F	C _{LOAD} = 10pF			1.6		ns
Shutdown Delay Time	t _{SD}	MAX998 only, V _{CC} = 5V, I _{CC} = 10% of typical			5		μs

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ELECTRICAL CHARACTERISTICS (continued)

($V_{CC} = +2.7V$ to $+5.5V$, $V_{CM} = 0V$, $T_A = -40^{\circ}C$ to $+85^{\circ}C$, unless otherwise noted. Typical values are at $T_A = +25^{\circ}C$.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Wake-Up from Shutdown	t_{EN}	MAX998 only, $V_{CC} = 5V$, $I_{CC} = 90\%$ of typical (Note 7)		15		μs
Power-Up Delay	t_{PU}	$V_{CC} = 0V$ to $5V$ step, output valid		3		μs

Note 1: The MAX998EUT specifications are 100% tested at $T_A = +25^{\circ}C$. Limits over the extended temperature range are guaranteed by design, not production tested.

Note 2: Inferred from CMRR test. Either input can be driven to the absolute maximum limit without false output inversion, as long as the other input is within the common-mode voltage range.

Note 3: V_{OS} is defined as the mean of trip points. The trip points are the extremities of the differential input voltage required to make the comparator output change state (Figure 1).

Note 4: The difference between the upper and lower trip points is equal to the width of the input-referred hysteresis zone (Figure 1).

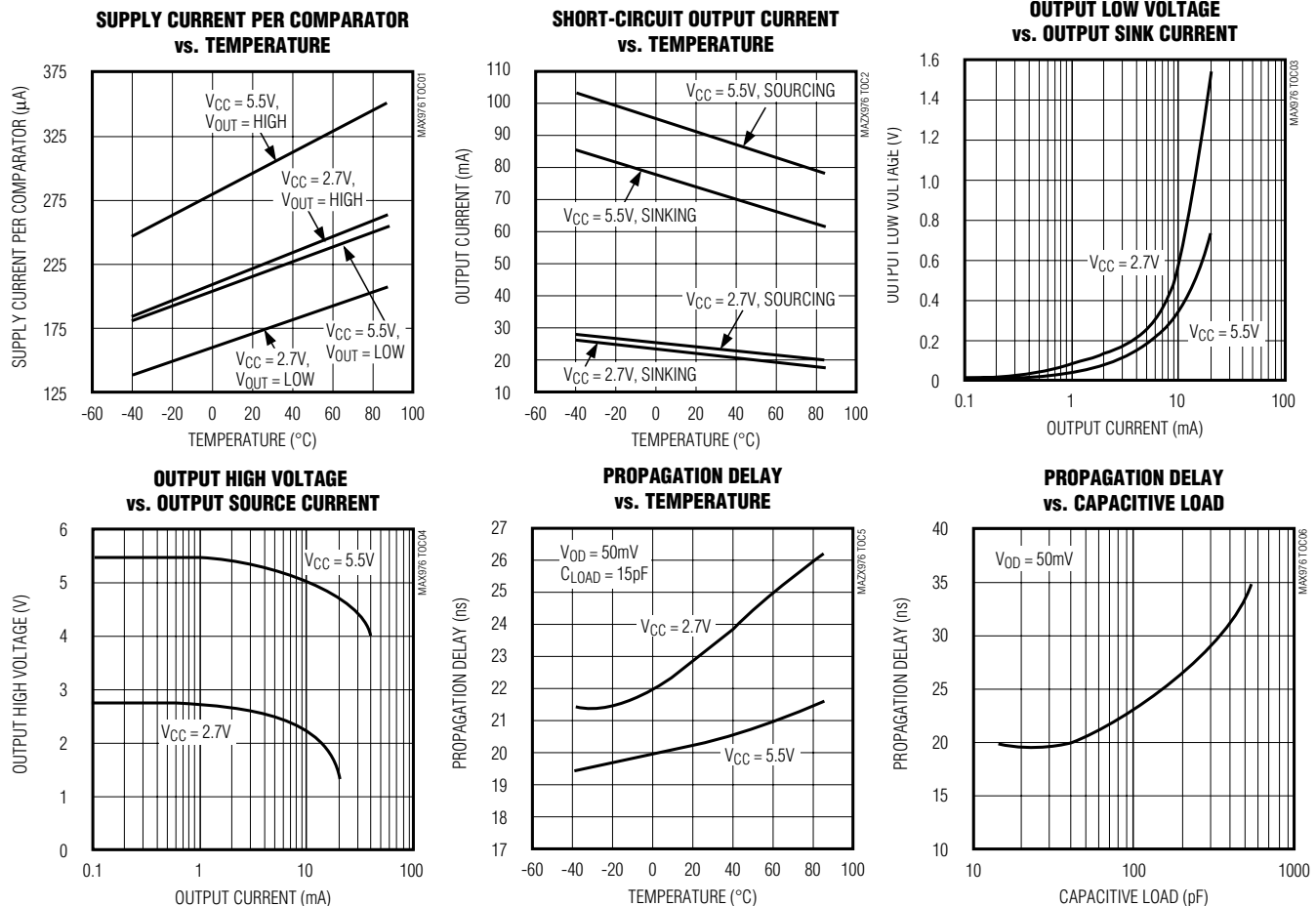
Note 5: Propagation Delay is guaranteed by design. For low overdrive conditions, V_{TRIP} (Figure 1) is added to the overdrive.

Note 6: Propagation-Delay Skew is the difference between the positive-going and the negative-going propagation delay.

Note 7: For design purposes, the t_{EN} can be as high as $60\mu s$.

Typical Operating Characteristics

($V_{CC} = +5V$, $V_{CM} = 0V$, $T_A = +25^{\circ}C$, unless otherwise noted.)

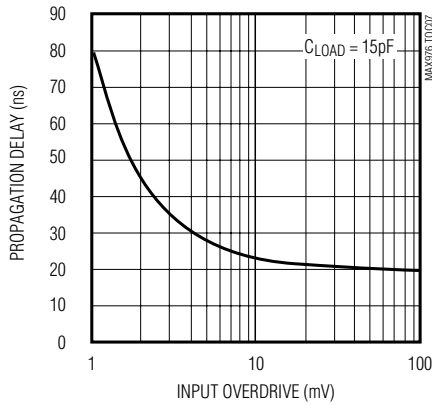


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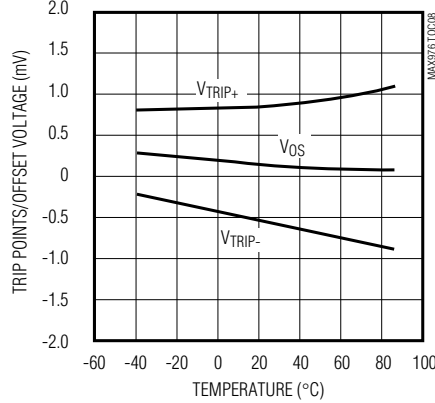
Typical Operating Characteristics (continued)

($V_{CC} = +5V$, $V_{CM} = 0V$, $T_A = +25^\circ C$, unless otherwise noted.)

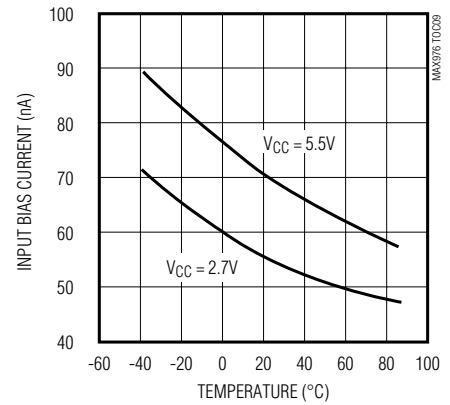
**PROPAGATION DELAY
vs. INPUT OVERDRIVE**



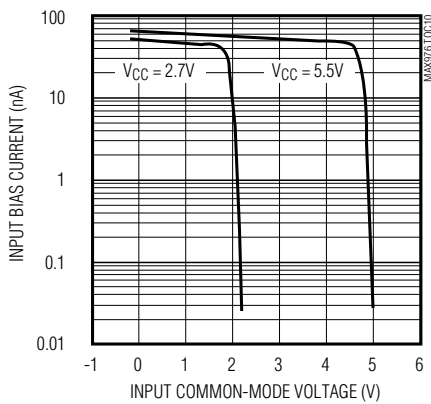
**TRIP POINTS AND OFFSET VOLTAGE
vs. TEMPERATURE**



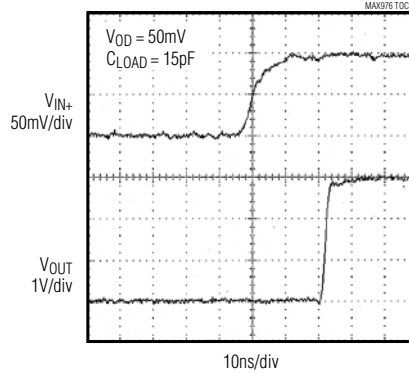
**INPUT BIAS CURRENT
vs. TEMPERATURE**



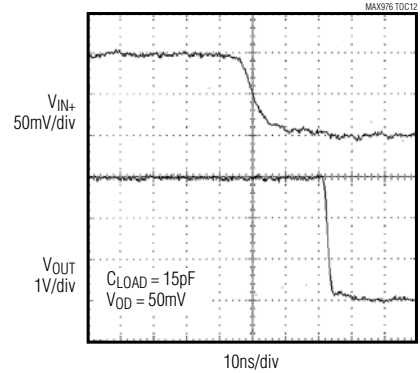
**INPUT BIAS CURRENT
vs. INPUT COMMON-MODE VOLTAGE**



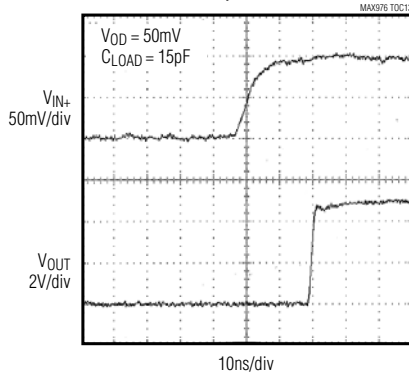
**PROPAGATION DELAY
(t_{PD+} , $V_{CC} = 3V$)**



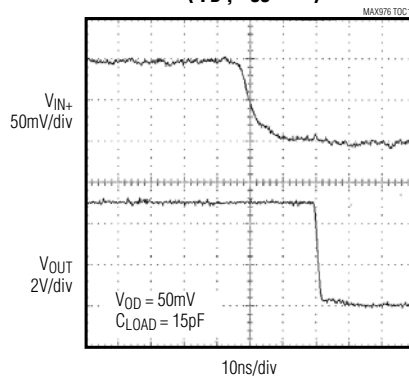
**PROPAGATION DELAY
(t_{PD-} , $V_{CC} = 3V$)**



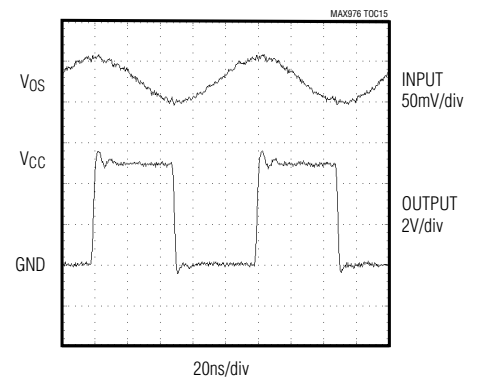
**PROPAGATION DELAY
(t_{PD+} , $V_{CC} = 5V$)**



**PROPAGATION DELAY
(t_{PD-} , $V_{CC} = 5V$)**



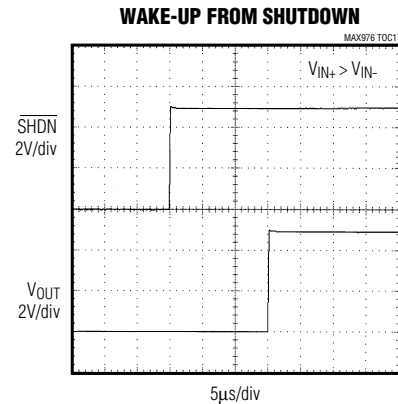
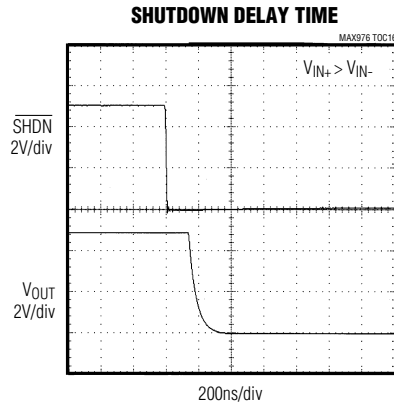
10MHz RESPONSE



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Typical Operating Characteristics (continued)

($V_{CC} = +5V$, $V_{CM} = 0V$, $T_A = +25^{\circ}C$, unless otherwise noted.)



Pin Description

PIN				NAME	FUNCTION
MAX976	MAX978	MAX998			
SO/ μ MAX	SO/QSOP	SOT23-6	SO		
1, 3	1, 3, 5, 7	3	3	IN_+	Comparator Noninverting Input
2, 4	2, 4, 6, 8	4	2	IN_-	Comparator Inverting Input
5	9, 13	2	4	GND	Ground
6, 7	10, 11, 14, 15	1	6	OUT_	Comparator Output
8	12, 16	6	7	V _{CC}	Supply Voltage, +2.7V to +5.5V
—	—	—	1,5	N.C.	No Connection. Not internally connected.
—	—	5	8	$\overline{\text{SHDN}}$	Shutdown Input. Drive low for shutdown mode. Drive high or connect to V _{CC} for normal operation.

Detailed Description

The MAX976/MAX978/MAX998 dual/quad/single comparators operate from a single +2.7V to +5.5V supply. They achieve a 20ns propagation delay while consuming only 225 μ A of supply current per comparator. The MAX998 features a low-power shutdown mode that places the output in a high-impedance state and reduces supply current to 1nA. Activate shutdown mode by driving SHDN low.

The MAX976/MAX978/MAX998 comparator inputs have a common-mode voltage range of -0.2V to ($V_{CC} - 1.2V$).

Either input can be driven to the Absolute Maximum Ratings limit without false output inversion, as long as the other input is within the Common-Mode Voltage Range. Their push/pull output structure is capable of rail-to-rail operation without external pull-up circuitry, making these devices ideal for interfacing with CMOS/TTL logic. All inputs and outputs can tolerate a continuous short-circuit fault condition to either supply. The comparator's internal hysteresis ensures clean output switching, even with slow-moving input signals.

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Hysteresis

High-speed comparators can oscillate in the linear operating region because of noise or undesired parasitic feedback. This tends to occur when the voltage on one input is equal to or very close to the voltage on the other input. The MAX976/MAX978/MAX998 have internal hysteresis to counter parasitic effects and noise. The hysteresis in a comparator creates two trip points: one for the rising input voltage and one for the falling input voltage (Figure 1). The difference between the trip points is the hysteresis. When the comparator input voltages are equal, the hysteresis effectively causes one comparator input voltage to move quickly past the other, taking the input out of the region where oscillation occurs.

Figure 1 illustrates the case where $IN-$ has a fixed voltage applied and $IN+$ is varied. If the inputs were reversed, the figure would be the same, except with an inverted output.

Input-Stage Circuitry

The MAX976/MAX978/MAX998 input common-mode voltage range is from $-0.2V$ to $(V_{CC} - 1.2V)$. The voltage range for each comparator input extends to both V_{CC} and GND. The output remains in the correct logic state while one or both of the inputs are within the common-mode range. If both input levels are out of the common-mode range, input-stage current saturation occurs, and the output becomes unpredictable.

Shutdown Mode

The MAX998 features a low-power shutdown mode, which is activated by forcing $\overline{SHDN}$ low. Shutdown mode reduces the supply current to 1nA (typical), disables the comparator, and places the output in a high-impedance state. Drive $\overline{SHDN}$ high to enable the comparator. Do not leave $\overline{SHDN}$ unconnected. Since it is a high-impedance input, leaving $\overline{SHDN}$ unconnected could result in indeterminate logic levels, adversely

affecting comparator operation. Likewise, do not three-state $\overline{SHDN}$. Due to the output leakage currents of three-state devices and the small internal current for $\overline{SHDN}$, three-stating this pin could also result in indeterminate logic levels.

The maximum input voltage for $\overline{SHDN}$ is 6V, referred to GND, and is not limited by V_{CC} . This allows the use of 5V logic to drive $\overline{SHDN}$ while V_{CC} operates at a lower voltage, such as 3V. The logic threshold limits for $\overline{SHDN}$ are proportional to V_{CC} (see *Electrical Characteristics*).

Applications Information

Circuit Layout and Bypassing

The MAX976/MAX978/MAX998 have a high-gain bandwidth and require careful board layout. We recommend the following design guidelines:

- 1) Use a printed circuit board with an unbroken, low-inductance ground plane. Surface-mount components are recommended.
- 2) Place a decoupling capacitor (a 0.1 μ F ceramic capacitor is a good choice) between V_{CC} and ground as close to the pins as possible.
- 3) Keep lead lengths short on the inputs and outputs to avoid unwanted parasitic feedback around the comparators.
- 4) Solder the devices directly to the printed circuit board instead of using a socket.
- 5) Minimize input impedance.
- 6) For slowly varying inputs, use a small capacitor ($\sim 1000pF$) across the inputs to improve stability.

Additional Hysteresis

Generate additional hysteresis with three resistors using positive feedback, as shown in Figure 2. This positive feedback method slows the hysteresis response time. Calculate resistor values as follows:

- 1) Select R_3 . The leakage current of $IN+$ is typically 75nA, so the current through R_3 should be at least 1.0 μ A to minimize errors caused by leakage current. The current through R_3 at the trip point is $(V_{REF} - V_{OUT}) / R_3$. Consider the two possible output states when solving for R_3 . The two formulas are:

$$R_3 = V_{REF} / 1.0\mu A$$

or

$$R_3 = (V_{CC} - V_{REF}) / 1.0\mu A$$

Use the smaller of the two resulting resistor values. For example, if $V_{REF} = 1.2V$ and $V_{CC} = 5.0V$, the two resistor values are 1.2M Ω and 3.8M Ω . Choose a standard value for R_3 of 1.2M Ω .

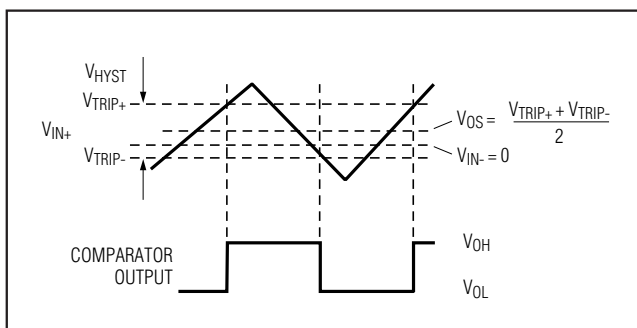


Figure 1. Input and Output Waveforms, Noninverting Input Varied

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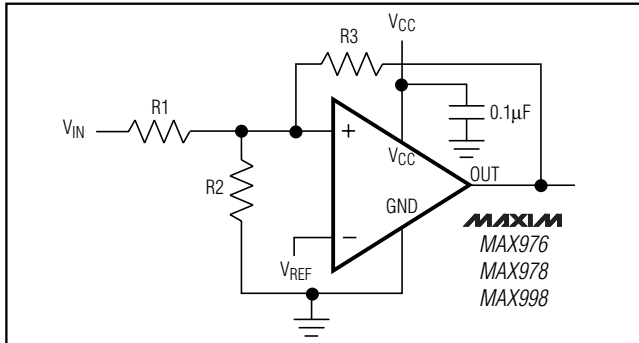


Figure 2. Additional Hysteresis

- 2) Choose the hysteresis band required (V_{HB}). For this example, choose 100mV.
- 3) Calculate R1. $R1 = R3 \times (V_{HB} / V_{CC})$. Plugging in the values for this example,

$$R1 = 1.2M\Omega \times (100mV / 5.0V) = 24k\Omega$$

- 4) Choose the trip point for V_{IN} rising. This is the threshold voltage at which the comparator switches from low to high as V_{IN} rises above the trip point. In this example, choose 3.0V.
- 5) Calculate R2 as follows:

$$R2 = \frac{1}{\left(\frac{V_{THR}}{V_{REF} \times R1}\right) - \frac{1}{R1} - \frac{1}{R3}}$$

$$R2 = \frac{1}{\left(\frac{3.0V}{1.2 \times 24k\Omega}\right) - \frac{1}{24k\Omega} - \frac{1}{1.2M}} = 16.2k\Omega$$

Choose a standard value for R2 of 16k Ω .

- 6) Verify the trip voltage and hysteresis as follows:

$$V_{IN} \text{ rising: } V_{THR} = V_{REF} \times R1 \times \left(\frac{1}{R1} + \frac{1}{R2} + \frac{1}{R3}\right)$$

$$V_{IN} \text{ falling: } V_{THF} = V_{THR} - \left(\frac{R1 \times V_{CC}}{R3}\right)$$

$$\text{Hysteresis} = V_{THR} - V_{THF}$$

IR Receiver

The *Typical Operating Circuit* shows an application using the MAX998 as an infrared receiver. The infrared photodiode creates a current relative to the amount of infrared light present. This current creates a voltage across R_D . When this voltage level crosses the voltage applied by the voltage divider to the inverting input, the output transitions.

Window Comparator

The MAX976 is ideal for making a window detector (undervoltage/overvoltage detector). The schematic shown in Figure 3 uses a MAX6120 reference and component values selected for a 2.0V undervoltage threshold and a 2.5V overvoltage threshold. Choose different thresholds by changing the values of R1, R2, and R3. OUTA provides an active-low undervoltage indication, and OUTB gives an active-low overvoltage indication. ANDing the two outputs provides an active-high, power-good signal. The design procedure is as follows:

- 1) Select R1. The leakage current into INB- is normally 75nA, so the current through R1 should exceed 1.0 μ A for the thresholds to be accurate. R1 values in the 50k Ω to 100k Ω range are typical.
- 2) Choose the overvoltage threshold (V_{OTH}) when V_{IN} is rising, and calculate R2 and R3 with the following formula:

$$R_{SUM} = R2 + R3 = R1 \times [V_{OTH} / (V_{REF} + V_H) - 1]$$

where $V_H = 1/2V_{HYST}$.

- 3) Choose the undervoltage threshold (V_{UTH}) when V_{IN} is falling, and calculate R2 with the following formula:

$$R2 = (R1 + R_{SUM}) \times [(V_{REF} - V_H) / V_{UTH}] - R1$$

where $V_H = 1/2V_{HYST}$.

- 4) Calculate R3 with the following formula:

$$R3 = (R_{SUM}) - R2$$

- 5) Verify the resistor values. The equations are as follows:

$$V_{OTH} = (V_{REF} + V_H) \times (R1 + R2 + R3) / R1$$

$$V_{UTH} = (V_{REF} - V_H) \times (R1 + R2 + R3) / (R1 + R2)$$

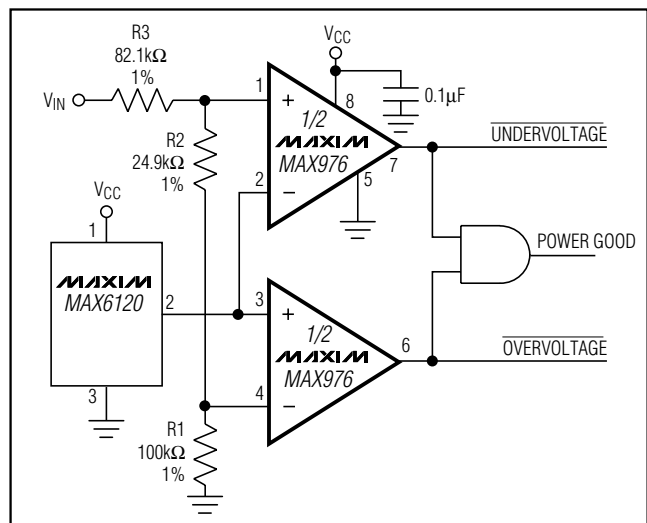
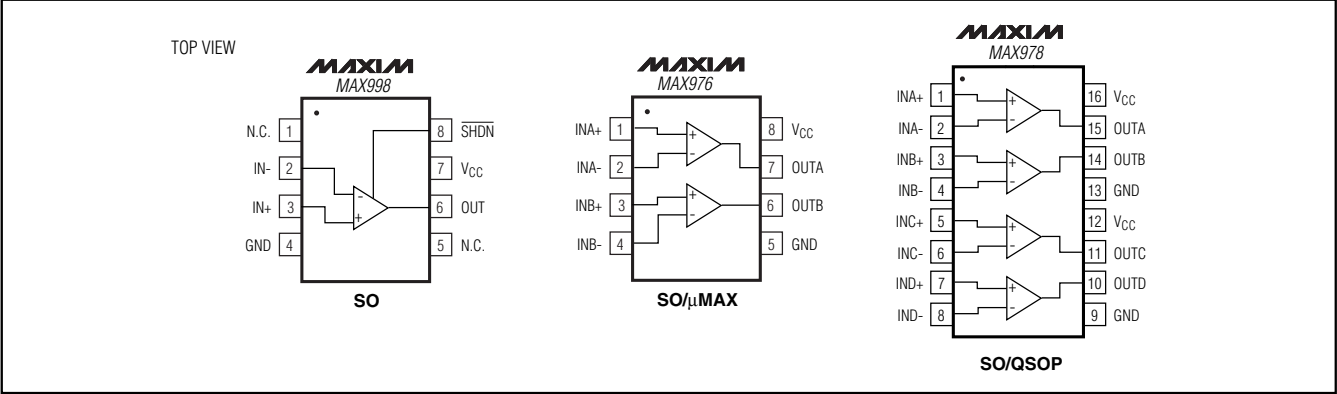


Figure 3. Window Comparator

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Pin Configurations (continued)



Chip Information

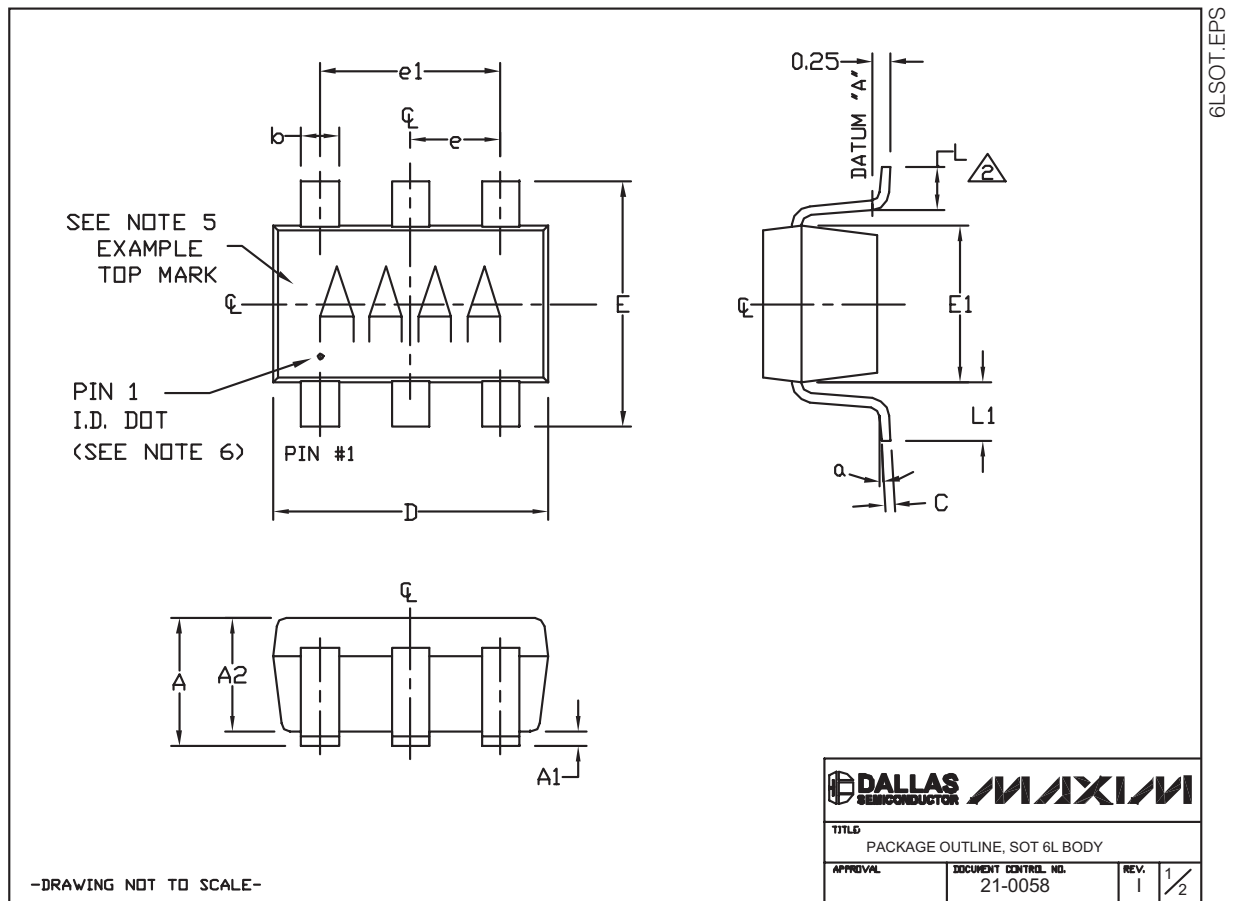
PROCESS: CMOS

Single/Dual/Quad, SOT23, Single-Supply, High-Speed, Low-Power Comparators

Package Information

For the latest package outline information and land patterns, go to www.maxim-ic.com/packages.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
8 SO	S8-2	21-0041
16 SO	S16M-3	21-0041
16 QSOP	E16M-1	21-0055
6 SOT23	U6-2	21-0058
8 μ MAX	U8-1	21-0036



MAX976/MAX978/MAX998

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Package Information (continued)

For the latest package outline information and land patterns, go to www.maxim-ic.com/packages.

NOTES:

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. FOOT LENGTH MEASURED AT INTERCEPT POINT BETWEEN DATUM A & LEAD SURFACE.
3. PACKAGE OUTLINE EXCLUSIVE OF MOLD FLASH & METAL BURR. MOLD FLASH, PROTRUSION OR METAL BURR SHOULD NOT EXCEED 0.25mm.
4. PACKAGE OUTLINE INCLUSIVE OF SOLDER PLATING.
5. PIN 1 IS LOWER LEFT PIN WHEN READING TOP MARK FROM LEFT TO RIGHT. (SEE EXAMPLE TOP MARK)
6. PIN 1 I.D. DOT IS 0.3mm Ø MIN. LOCATED ABOVE PIN 1.
7. MEETS JEDEC MO17B, VARIATION AB.
8. SOLDER THICKNESS MEASURED AT FLAT SECTION OF LEAD BETWEEN 0.08mm AND 0.15mm FROM LEAD TIP.
9. LEAD TO BE COPLANAR WITHIN 0.1mm.
10. NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY.
11. MARKING IS FOR PACKAGE ORIENTATION REFERENCE ONLY.

SYMBOL	MIN	NOMINAL	MAX
A	0.90	1.25	1.45
A1	0.00	0.05	0.15
A2	0.90	1.10	1.30
b	0.35	0.40	0.50
C	0.08	0.15	0.20
D	2.80	2.90	3.00
E	2.60	2.80	3.00
E1	1.50	1.625	1.75
L	0.35	0.45	0.60
L1	0.60 REF.		
e1	1.90 BSC.		
e	0.95 BSC.		
a	0*	2.5*	10*
PKG CODES:			
U6-1, U6-2, U6-4, U6C-8,			
U6SN-1, U6CN-2, U6S-3, U6F-5,			
U6F-6, U6FH-5, U6FH-6			

-DRAWING NOT TO SCALE-

 	
TITLE	
PACKAGE OUTLINE, SOT 6L BODY	
APPROVAL	DOCUMENT CONTROL NO.
	21-0058
REV.	2/2

Single/Dual/Quad, SOT23, Single-Supply, High-Speed, Low-Power Comparators

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	10/97	Initial release	—
1	1/98	Adding specs for MAX998	—
2	1/07	Adding input current ratings to Abs Max	—
3	3/09	Update Chip Information, Package Info, correct unit measurement in TOC 8, style changes	1, 3, 4, 8

MAX976/MAX978/MAX998

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